

PHOTOCOUPLER PS2701A-1

HIGH ISOLATION VOLTAGE SOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS2701A-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor to realize an excellent cost performance.

This package is SOP (Small Outline Package) type and has shield effect to cut off ambient light.

It is designed for high density mounting applications.

FEATURES

- High isolation voltage (BV = 3 750 Vr.m.s.)
- SOP (Small Outline Package) type
- Ordering number of taping product: PS2701A-1-F3, F4
- Pb-Free product
 - · Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

APPLICATIONS

- Hybrid IC
- · Measuring instruments
- Power supply
- Programmable logic controllers

PIN CONNECTION (Top View) 4 3 4 4 4 4 4 2 2 Cathode 3. Emitter 4. Collector

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PACKAGE DIMENSIONS (in millimeters)



MARKING EXAMPLE



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS2701A-1	PS2701A-1	Solder	Magazine case 100 pcs	Standard products	PS2701A-1
PS2701A-1-F3	PS2701A-1-F3	contains lead	Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2701A-1-F4	PS2701A-1-F4				
PS2701A-1-V	PS2701A-1-V		Magazine case 100 pcs	DIN EN60747-5-2	
PS2701A-1-V-F3	PS2701A-1-V-F3		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2701A-1-V-F4	PS2701A-1-V-F4			Approved (Option)	
PS2701A-1	PS2701A-1-A	Pb-Free	Magazine case 100 pcs	Standard products	
PS2701A-1-F3	PS2701A-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2701A-1-F4	PS2701A-1-F4-A				
PS2701A-1-V	PS2701A-1-V-A		Magazine case 100 pcs	DIN EN60747-5-2	
PS2701A-1-V-F3	PS2701A-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2701A-1-V-F4	PS2701A-1-V-F4-A]		Approved (Option)	

*1 For the application of the Safety Standard, following part number should be used.

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	30	mA
	Reverse Voltage	Vr	6	V
	Power Dissipation Derating	⊿Po/°C	0.8	mW/°C
	Power Dissipation	Po	80	mW
	Peak Forward Current ^{*1}	IFP	0.5	А
Transistor	Collector to Emitter Voltage	Vceo	70	V
	Emitter to Collector Voltage	Veco	5	V
	Collector Current	lc	30	mA
	Power Dissipation Derating	⊿Pc/°C	1.5	mW/°C
	Power Dissipation	Pc	150	mW
Isolation Voltage ^{*2}		BV	3 750	Vr.m.s.
Operating Ambient Temperature		TA	–55 to +100	°C
Storage Temperature		Tstg	–55 to +150	°C

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

***1** PW = 100 μs, Duty Cycle = 1%

*2 AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 5 mA		1.2	1.4	V
	Reverse Current	Ir	V _R = 5 V			5	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		10		pF
Transistor	Collector to Emitter Dark Current	ICEO	IF = 0 mA, VCE = 70 V			100	nA
Coupled	Current Transfer Ratio (Ic/IF) ^{*1}	CTR	IF = 5 mA, VCE = 5 V	50		300	%
	Collector Saturation Voltage	Vce (sat)	I⊧ = 10 mA, Ic = 2 mA		0.13	0.3	V
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 ¹¹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time *2	tr	$V_{CC} = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ R}_{L} = 100 \Omega$		5		μs
	Fall Time *2	tr			7		

*1 CTR rank

- N: 50 to 300 (%)
- P: 150 to 300 (%)
- L: 100 to 300 (%)
- M: 50 to 150 (%)
- *2 Test circuit for switching time



* TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)



Remark The graphs indicate nominal characteristics.



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TAPING SPECIFICATIONS (in millimeters)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

 Peak temperature (lead part temperature) 	350°C or below
 Time (each pins) 	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentratio in CEL	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
РВВ	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.

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